SURFACE MOUNT top hat®

RF Transformer

TCM2-43X+

50Ω 10 to 4000 MHz

FEATURES

- Wide bandwidth 10 to 4000 MHz
- Balanced transmission line
- Excellent return loss
- Aqueous washable

Generic photo used for illustration purposes only

CASE STYLE: DB1627

+RoHS Compliant
The +Suffix identifies RoHS Compliance.
See our website for methodologies and qualifications

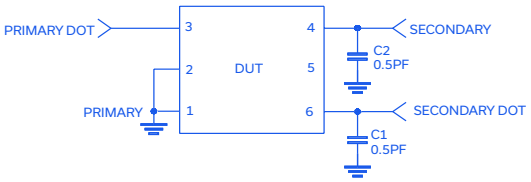
APPLICATIONS

- PCS
- Wideband push-pull amplifiers
- Cellular

ELECTRICAL SPECIFICATIONS AT 25°C

Parameter	Frequency (MHz)	Min.	Typ.	Max.	Units
Impedance Ratio (secondary/primary)			2		Ohm
Frequency Range		10		4000	MHz
Insertion Loss	10-4000	—	1.3	3.0	dB
Amplitude Unbalance	10-4000	—	0.5	—	dB
Phase Unbalance	10-4000	—	7	—	Degree

ELECTRICAL SCHEMATIC

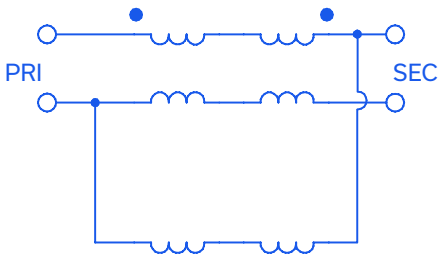


MAXIMUM RATINGS

Parameter	Ratings
Operating Temperature	-40°C to 85°C
Storage Temperature	-55°C to 100°C
RF Power	0.4 W
DC Curret	30 mA

Permanent damage may occur if any of these limits are exceeded.

CONFIGURATION K



REV. B
ECO-013812
TCM2-43X+
DJ/CP/AM
220620

SURFACE MOUNT top hat

RF Transformer

TCM2-43X+

50Ω 10 to 4000 MHz

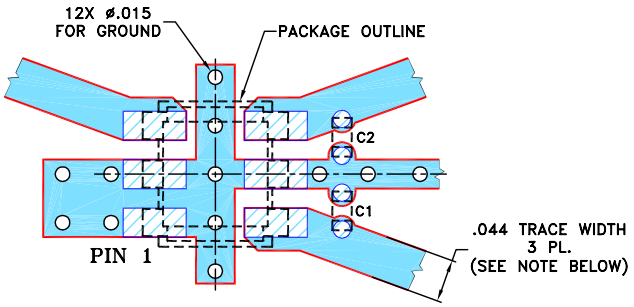
PIN CONNECTIONS

PRIMARY DOT	3
PRIMARY	1,2
SECONDARY DOT	6
SECONDARY	4
GND	1,2
NOT USED	5

PRODUCT MARKING: GJ

DEMOBOARD MCL P/N: TB-TCM2-43X+

SUGGESTED PCB LAYOUT (PL-380)

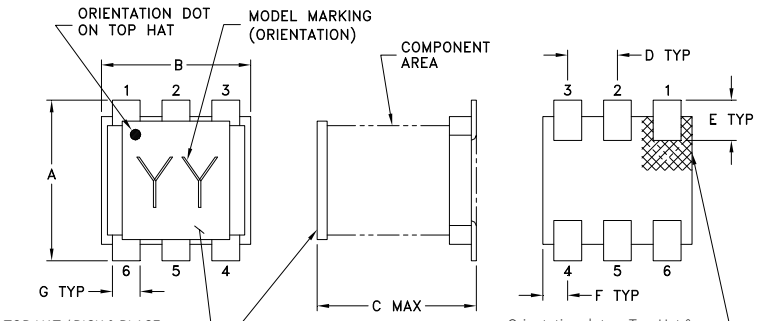


COMPONENT	SIZE
C1, C2	0402

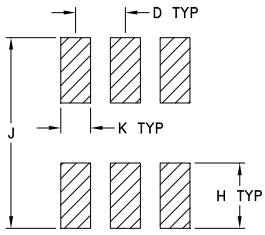
NOTES: 1. TRACE WIDTH IS SHOWN FOR ROGERS RO4350B WITH DIELECTRIC THICKNESS .020" ± .0015"; COPPER: 1/2 OZ. EACH SIDE. FOR OTHER MATERIALS TRACE WIDTH MAY NEED TO BE MODIFIED.
2. BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.
3. CHIP COMPONENT FOOT PRINTS SHOWN FOR REFERENCE. FOR COMPONENT VALUES REFER TO TB-676+.

DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER)

OUTLINE DRAWING



PCB Land Pattern



SUGGESTED LAYOUT
TOLERANCE TO BE WITHIN ±.002

OUTLINE DIMENSIONS (Inches / mm)

A	B	C	D	E	F
.160	.150	.160	.050	.040	.025
4.06	3.81	4.06	1.27	1.02	0.64

G	H	J	K		wt
.028	.065	.190	.030		grams
0.71	1.65	4.83	0.76		0.15

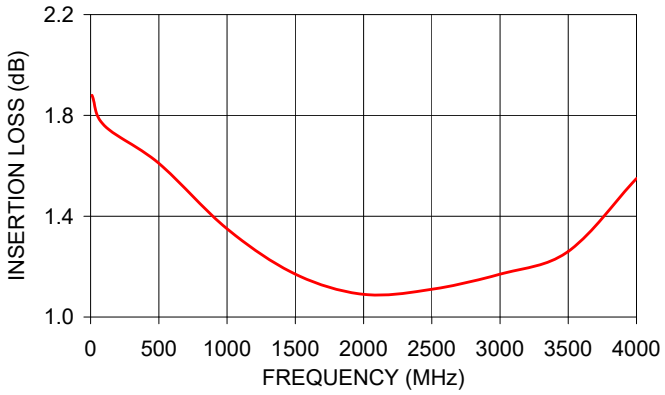
TAPE & REEL INFORMATION: F47

TYPICAL PERFORMANCE DATA

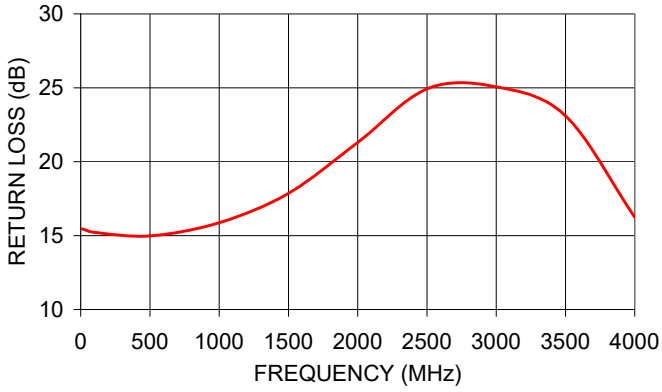
Frequency (MHz)	Insertion Loss (dB)	Return Loss (dB)	Amplitude Unbalance (dB)	Phase Unbalance (deg)
10	1.88	15.46	0.08	0.74
100	1.76	15.22	0.03	1.07
500	1.61	14.98	0.24	4.40
1000	1.35	15.87	0.32	5.96
1500	1.17	17.86	0.09	6.73
2000	1.09	21.30	0.23	7.01
2500	1.11	24.93	0.52	7.71
3000	1.17	25.06	0.82	6.95
3500	1.26	23.10	0.79	5.04
4000	1.55	16.24	0.81	3.16

0

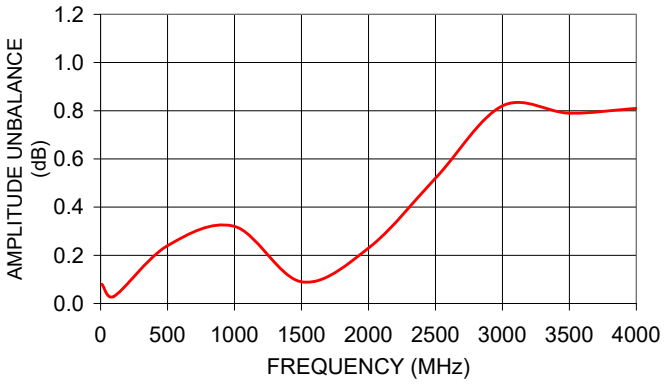
INSERTION LOSS



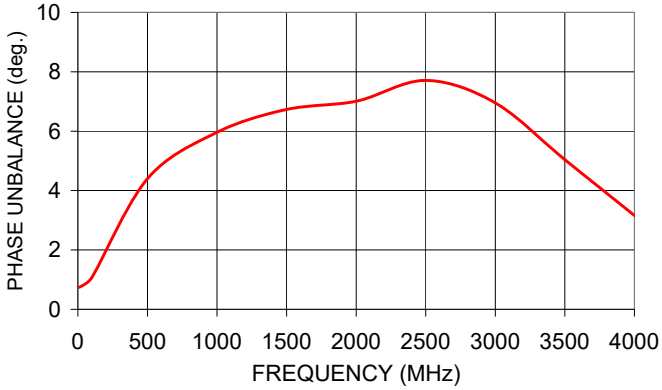
INPUT RETURN LOSS



AMPLITUDE UNBALANCE



PHASE UNBALANCE



NOTES

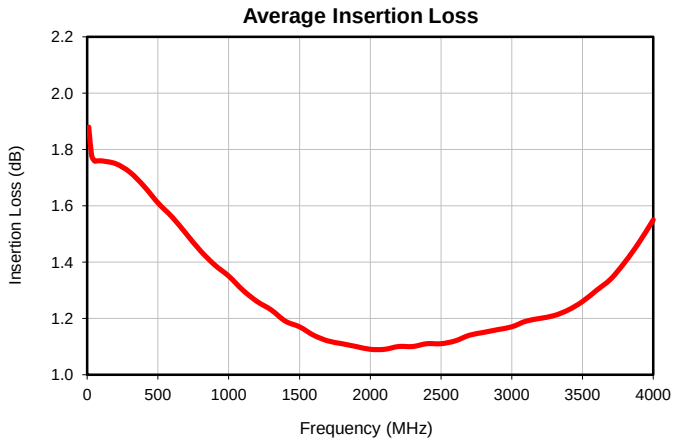
A. Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document.
B. Electrical specifications and performance data contained in this specification document are based on Mini-Circuit's applicable established test performance criteria and measurement instructions.
C. The parts covered by this specification document are subject to Mini-Circuits standard limited warranty and terms and conditions (collectively, "Standard Terms"); Purchasers of this part are entitled to the rights and benefits contained therein. For a full statement of the standard. Terms and the exclusive rights and remedies thereunder, please visit Mini-Circuits' website at www.minicircuits.com/terms/viewterm.html

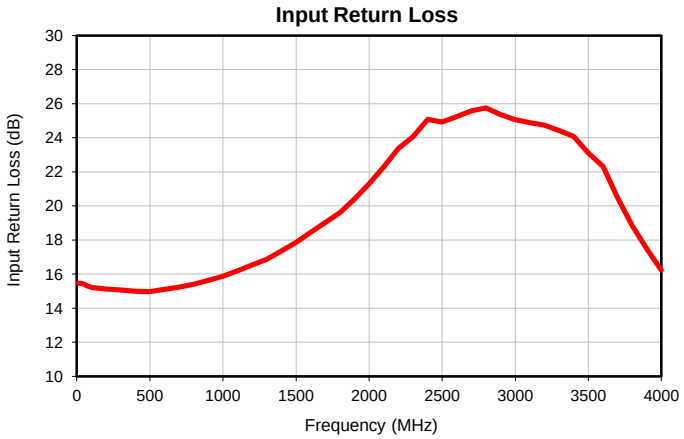
RF Transformer TCM2-43X+

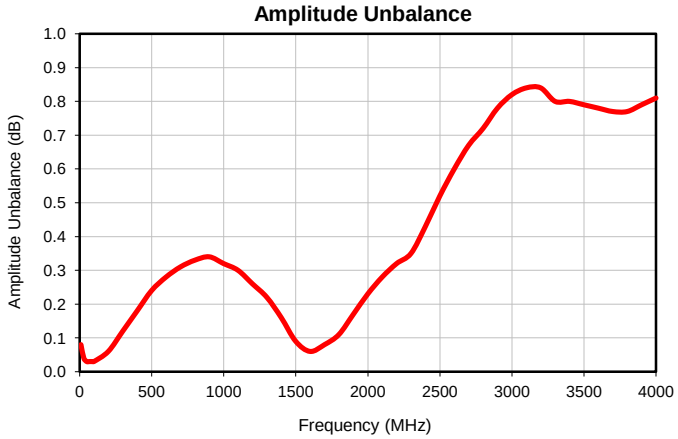
Typical Performance Data

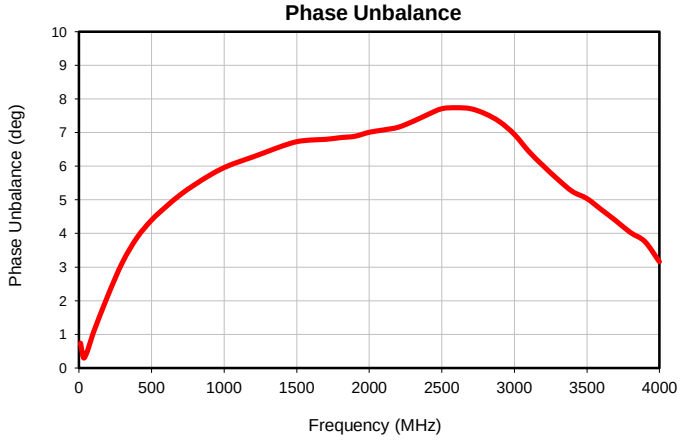
FREQUENCY (MHz)	AVERAGE INSERTION LOSS (dB)	INPUT RETURN LOSS (dB)	AMPLITUDE UNBALANCE (dB)	PHASE UNBALANCE (deg.)
10.0	1.88	15.46	0.08	0.74
30.0	1.78	15.47	0.04	0.31
50.0	1.76	15.41	0.03	0.42
70.0	1.76	15.32	0.03	0.67
90.0	1.76	15.25	0.03	0.94
100.0	1.76	15.22	0.03	1.07
200.0	1.75	15.12	0.06	2.17
300.0	1.72	15.07	0.12	3.15
400.0	1.67	14.99	0.18	3.88
500.0	1.61	14.98	0.24	4.40
600.0	1.56	15.10	0.28	4.80
700.0	1.50	15.24	0.31	5.16
800.0	1.44	15.41	0.33	5.46
900.0	1.39	15.63	0.34	5.73
1000.0	1.35	15.87	0.32	5.96
1100.0	1.30	16.19	0.30	6.13
1200.0	1.26	16.53	0.26	6.28
1300.0	1.23	16.87	0.22	6.44
1400.0	1.19	17.36	0.16	6.60
1500.0	1.17	17.86	0.09	6.73
1600.0	1.14	18.45	0.06	6.78
1700.0	1.12	19.03	0.08	6.80
1800.0	1.11	19.62	0.11	6.85
1900.0	1.10	20.40	0.17	6.89
2000.0	1.09	21.30	0.23	7.01
2100.0	1.09	22.29	0.28	7.08
2200.0	1.10	23.36	0.32	7.16
2300.0	1.10	24.06	0.35	7.33
2400.0	1.11	25.08	0.43	7.53
2500.0	1.11	24.93	0.52	7.71
2600.0	1.12	25.24	0.60	7.74
2700.0	1.14	25.59	0.67	7.71
2800.0	1.15	25.75	0.72	7.56
2900.0	1.16	25.36	0.78	7.32
3000.0	1.17	25.06	0.82	6.95
3100.0	1.19	24.89	0.84	6.44
3200.0	1.20	24.74	0.84	6.01
3300.0	1.21	24.43	0.80	5.61
3400.0	1.23	24.09	0.80	5.25
3500.0	1.26	23.10	0.79	5.04
3600.0	1.30	22.31	0.78	4.71
3700.0	1.34	20.50	0.77	4.38
3800.0	1.40	18.85	0.77	4.03
3900.0	1.47	17.47	0.79	3.76
4000.0	1.55	16.24	0.81	3.16

Typical Performance Data





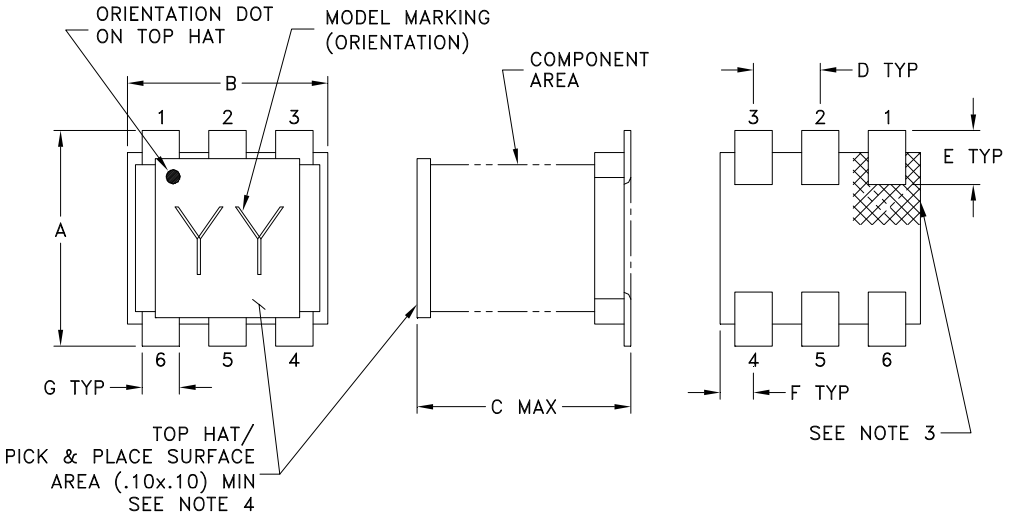




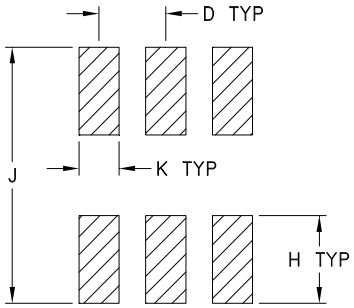
Case Style DB

DB1627

Outline Dimensions



PCB Land Pattern



SUGGESTED LAYOUT
TOLERANCE TO BE WITHIN ±.002

CASE #	A	B	C	D	E	F	G	H	J	K	WT. GRAM
DB1627	.160 (4.06)	.150 (3.81)	.160 (4.06)	.050 (1.27)	.040 (1.02)	.025 (0.64)	.028 (0.71)	.065 (1.65)	.190 (4.83)	.030 (0.76)	.15

Dimensions are in inches (mm). Tolerances: 2 Pl. ± .01; 3Pl. ± .005

Notes:

1. Case material: Plastic.
2. Termination finish:
   For RoHS Case Styles: Tin plate over Nickel plate. All models, (+) suffix.
   For RoHS-5 Case Styles: Tin-Lead plate. All models, no (+) suffix.
3 Orientation dot on top hat & orientation feature on substrate correspondence to pin #1.
4 Top-Hat total thickness: .013 inches MAX.

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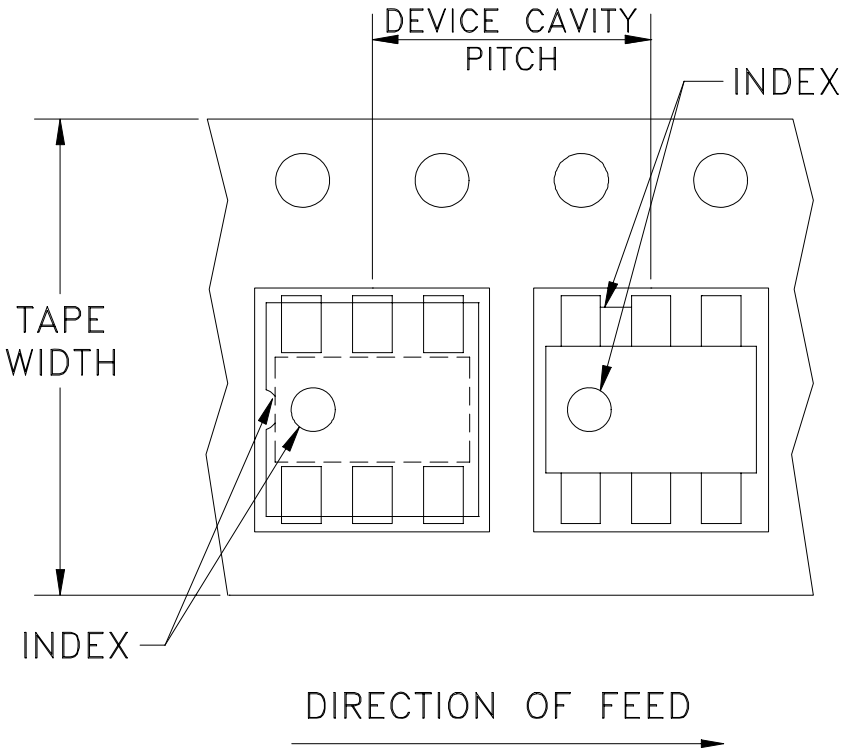
Tape & Reel Packaging TR-F47

DEVICE ORIENTATION IN T&R



Tape Width, mm	Device Cavity Pitch, mm	Reel Size, inches	Devices per Reel see note
12	8	13	1000, 2000
		7	20, 50, 100, 200, 500

Note: Please consult individual model data sheet to determine device per reel availability.

Mini-Circuits carrier tape materials provide protection from ESD (Electro-Static Discharge) during handling and transportation. Tapes are static dissipative and comply with industry standards EIA-481/EIA-541.

Go to: www.minicircuits.com/pages/pdfs/tape.pdf

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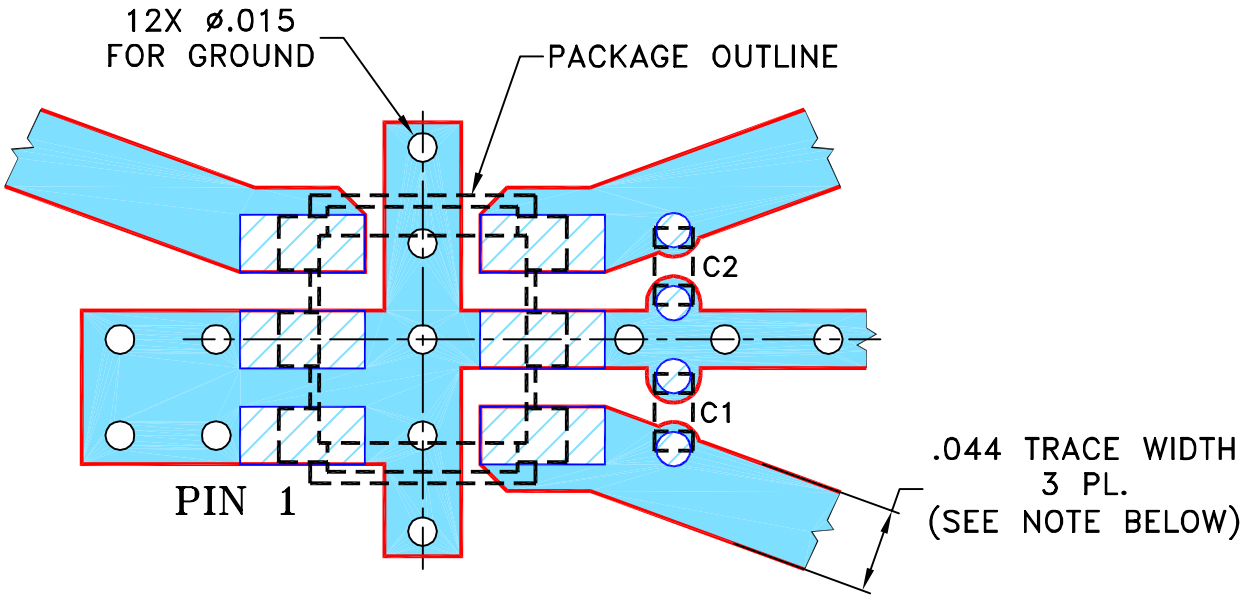
THIRD ANGLE PROJECTION

REVISIONS					
REV	ECN No.	DESCRIPTION	DATE	DR	AUTH
OR	M138367	NEW RELEASE	08/15/12	AV	DJ

SUGGESTED MOUNTING CONFIGURATION FOR DB1627 CASE STYLE, "06TK02" PIN CODE



COMPONENT	SIZE
C1, C2	0402

NOTES:
1. TRACE WIDTH IS SHOWN FOR ROGERS RO4350B WITH DIELECTRIC THICKNESS .020" ± .0015"; COPPER: 1/2 OZ. EACH SIDE. FOR OTHER MATERIALS TRACE WIDTH MAY NEED TO BE MODIFIED.
2. BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.
3. CHIP COMPONENT FOOT PRINTS SHOWN FOR REFERENCE. FOR COMPONENT VALUES REFER TO TB-676+.

DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER)

DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK

UNLESS OTHERWISE SPECIFIED		INITIALS	DATE
DIMENSIONS ARE IN INCHES	DRAWN	AV	08/13/12
TOLERANCES ON:	CHECKED	IL	08/15/12
2 PL DECIMALS ±	APPROVED	DJ	08/15/12
3 PL DECIMALS ± .005			
ANGLES ±			
FRACTIONS ±			

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ASHEETA1.DWG REV:A DATE:01/12/95

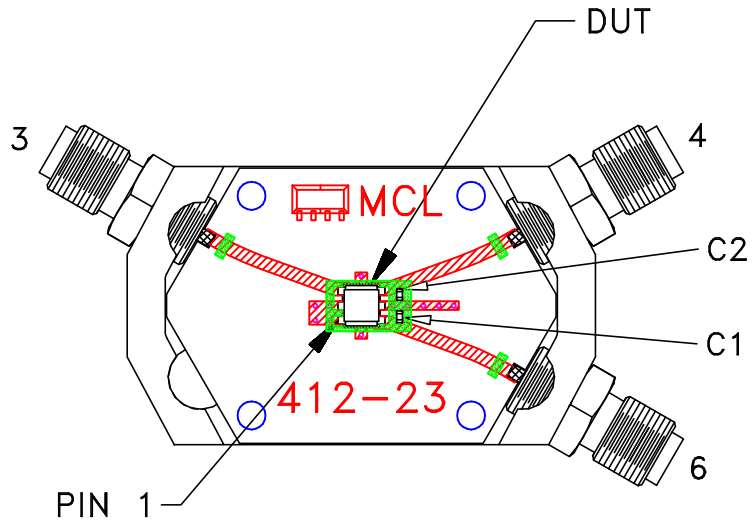
Mini-Circuits® 13 Neptune Avenue Brooklyn NY 11235

PL, 06TK02, DB1627, TB-676+

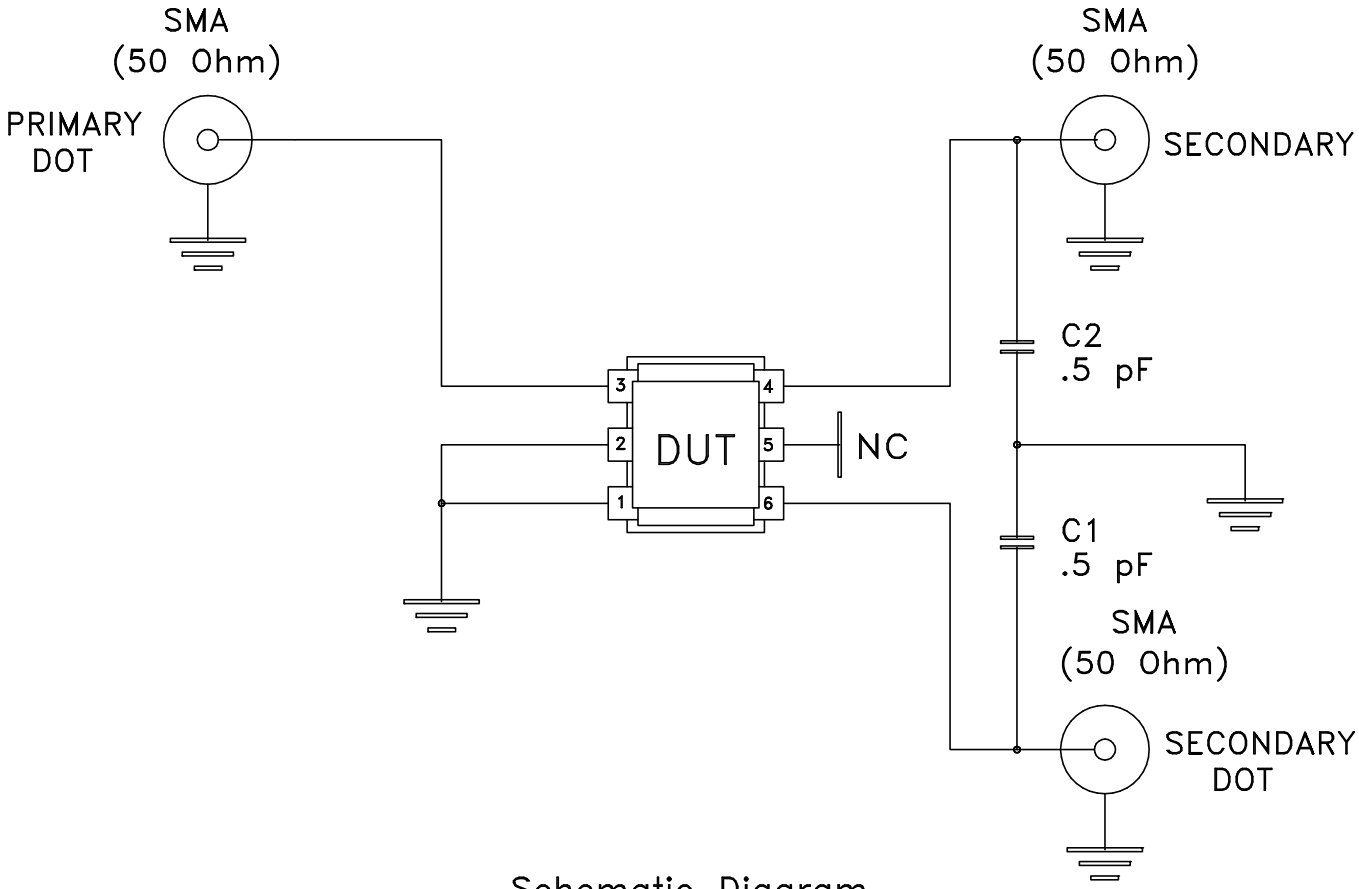
SIZE	CODE IDENT	DRAWING NO:	REV:
A	15542	98-PL-380	OR

FILE:	SCALE:	SHEET:
98PL380	10:1	1 OF 1

Evaluation Board and Circuit



TB-676+



Schematic Diagram

Notes:

1. 50 Ohm SMA Female connectors.
2. PCB Material: RO4350 or equivalent, Dielectric Constant=3.5, Thickness=.020 inch.

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Environmental Specifications ENV02T1

All Mini-Circuits products are manufactured under exacting quality assurance and control standards, and are capable of meeting published specifications after being subjected to any or all of the following physical and environmental test.

Specification	Test/Inspection Condition	Reference/Spec
Operating Temperature	-40° to 85°C Ambient Environment	Individual Model Data Sheet
Storage Temperature	-55° to 100° C Ambient Environment	Individual Model Data Sheet
Humidity	90 to 95% RH, 240 hours, 50°C	MIL-STD-202, Method 103, Condition A, Except 50°C and end-point electrical test done within 12 hours
Thermal Shock	-55° to 100°C, 100 cycles	MIL-STD-202, Method 107, Condition A-3, except +100°C
Solder Reflow Heat	Sn-Pb Eutetic Process: 225°C peak Pb-Free Process 245° - 250°C peak	J-STD-020, Table 4-1, 4-2 and 5-2, Figure 5-1
Solderability	10X Magnification	J-STD-002, 95% Coverage
Vibration (High Frequency)	20g peak, 10-2000 Hz, 12 times in each of three perpendicular directions (total 36)	MIL-STD-202, Method 204, Condition D
Mechanical Shock	50g, 11 ms, 1/2-sine, 18 shocks: 3 each direction, each of 3 axes	MIL-STD-202, Method 213, Condition A
Marking Resistance to Solvents	Isopropyl alcohol + mineral spirits at 25°C; terpene defluxer at 25°C; distilled water + proylene glycol monomethyl ether + monoethanolamine at 63°C to 70°C	MIL-STD-202, Method 215

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